

Serial No. 09/738,051
June 2, 2003
Reply to Office Action of January 3, 2003
Page 2 of 7

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

Claim 1 (canceled)

Claim 2 (currently amended): An electronic component module as claimed in claim 46, wherein the top surface of each of the circuit components mounted in said recess is substantially flush with the top surface of said circuit substrate.

Claim 3 (currently amended): An electronic component module as claimed in claim 46, wherein said circuit components define a quartz vibrator package.

Claim 4 (currently amended): An electronic component module as claimed in claim 46, wherein said circuit substrate is a ceramic circuit substrate.

Claim 5 (currently amended): An electronic component module as claimed in claim 46, wherein said circuit substrate is defined by a ceramic multi-layer substrate.

Claim 6 (currently amended): An electronic component module ~~as claimed in claim 4~~ comprising:

a circuit substrate having circuit components mounted thereon; and
a recess provided in the top surface of said circuit substrate, said recess including a plurality of regions where the thicknesses of bottom plates of said recess differ from one another, and said recess including at least one portion of the circuit components mounted on said circuit substrate; wherein

said circuit substrate includes a wall surrounding said recess, and connection electrodes are provided at four corners on a top surface of the wall.

Serial No. 09/738,051
June 2, 2003
Reply to Office Action of January 3, 2003
Page 3 of 7

Claim 7 (original): An electronic component module as claimed in claim 6, wherein said connection electrodes are arranged to define a connection with the circuit components.

Claim 8 (canceled)

Claim 9 (currently amended): An electronic component module as claimed in claim 813, wherein at least one ~~portion~~ of said plurality of recesses has a different depth from other than the remainder of said plurality of recesses.

Claim 10 (currently amended): An electronic component module as claimed in claim 813, wherein the top surface of each of the circuit components mounted in said recess is substantially flush with the top surface of said circuit substrate.

Claim 11 (currently amended): An electronic component module as claimed in claim 813, wherein said circuit components define a quartz vibrator package.

Claim 12 (currently amended): An electronic component module as claimed in claim 813, wherein said circuit substrate is a ceramic circuit substrate.

Claim 13 (currently amended): An electronic component module ~~as claimed in claim 8, comprising:~~

a circuit substrate; and

a plurality of recesses disposed on the top surface of the circuit substrate, and each of said plurality of recesses accommodating a circuit component; wherein

said circuit substrate includes a wall surrounding said recess, and connection electrodes are provided at four corners on a top surface of the wall.

Serial No. 09/738,051
June 2, 2003
Reply to Office Action of January 3, 2003
Page 4 of 7

Claim 14 (original): An electronic component module as claimed in claim 13, wherein said connection electrodes are arranged to be connected with the circuit components.

Claim 15 (currently amended): A piezoelectric oscillator comprising:
at least one oscillation circuit including an electronic component module as claimed in claim 14; and

a vibrator package accommodating a piezoelectric member, said vibrator package being stacked on said electronic component module, and said vibrator package being integrated with said electronic component module.

Claim 16 (original): A piezoelectric oscillator according to claim 15, wherein said vibrator package includes a case having an open top surface, said electronic component module being supported at both end portions thereof by said case.

Claim 17 (original): A piezoelectric oscillator according to claim 16, further comprising a shielding plate, wherein the entire top surface of the case is covered by the shielding plate, such that said electronic component module is hermetically sealed in said vibration package defined by the case and the shielding plate.

Claim 18 (currently amended): A piezoelectric oscillator comprising:
at least one oscillation circuit including an electronic component module as claimed in claim 13; and

a vibrator package accommodating a piezoelectric member, said vibrator package being stacked on said electronic component module, and said vibrator package being integrated with said electronic component module.

Serial No. 09/738,051
June 2, 2003
Reply to Office Action of January 3, 2003
Page 5 of 7

Claim 19 (original): A piezoelectric oscillator according to claim 18, wherein said vibrator package includes a case having an open top surface, said electronic component module being supported at both end portions thereof by said case.

Claim 20 (original): A piezoelectric oscillator according to claim 19, further comprising a shielding plate, wherein the entire top surface of the case is covered by the shielding plate, such that said electronic component module is hermetically sealed in said vibration package defined by the case and the shielding plate.